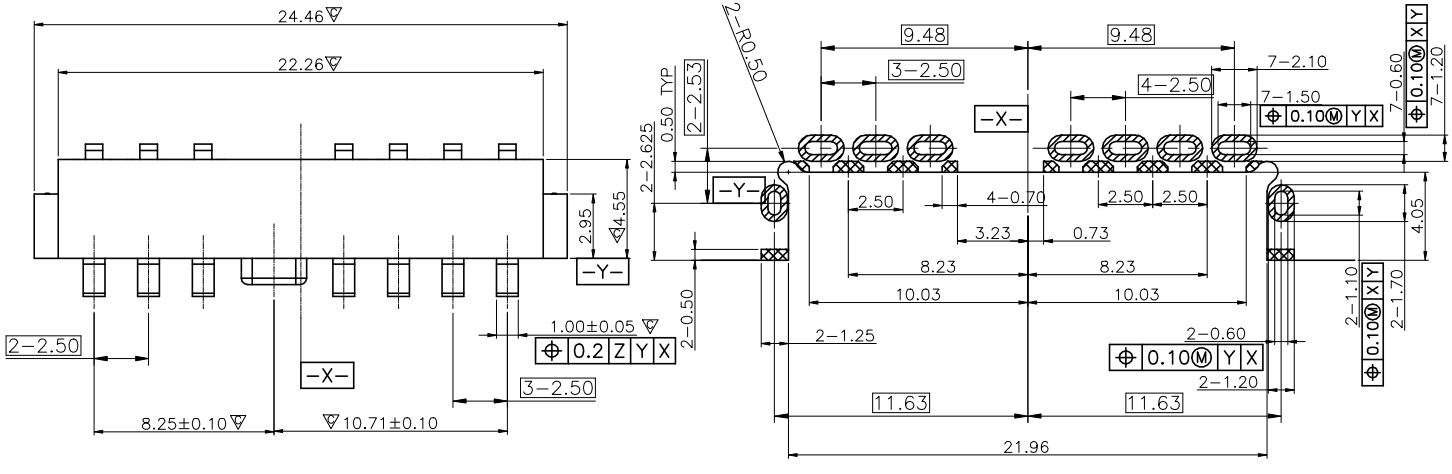
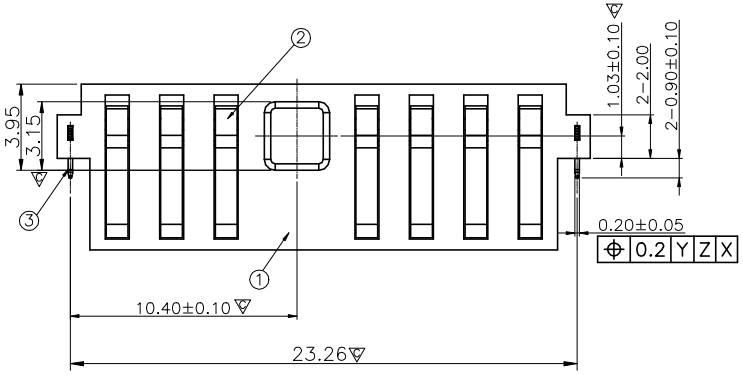
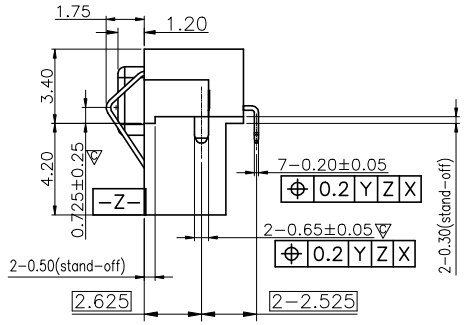
REV.	ECN NO.	DESCRIPTION	DATE	DESIGN
A		调整电气性能描述&更新图框	2021.10.26	XUETAOGUO



PAD STAND OFF
RECOMMENDED P.C.B LAYOUT (COMPONET SIDE)
P.C.B THICKNESS=0.8mm (TOLERANCE=±0.05)

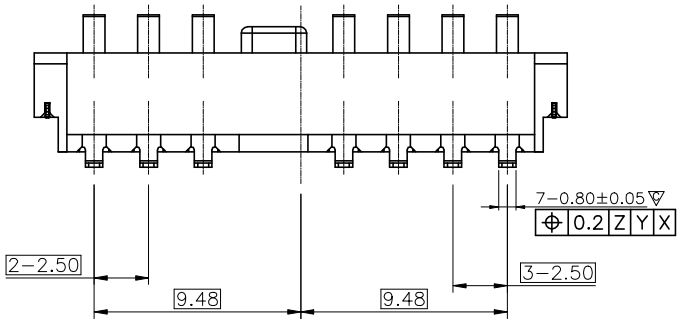


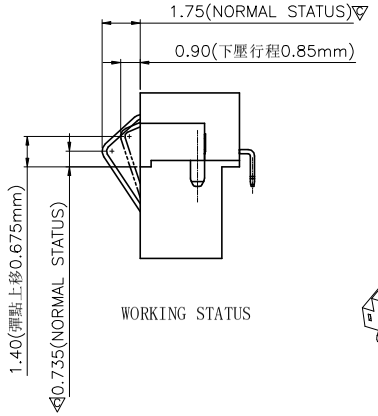


NORMAL
STATUS

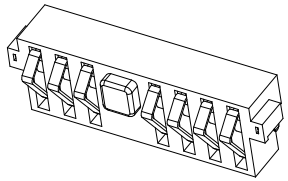
NOTE:
1.MATERIAL:SEE BOM
2.FINISH: CONTACT AREA
GOLD PLATING ON 50u" NICKEL PLATING OVERALL
SOLDER AREA: 100u" MIN.MATTE TIN ON,UNDER
50u" NICKEL PLATING OVERALL
3.UNLESS OTHERWISE SPECIFIED TOLERANCE:AS
SHOW AS GENERAL TOLERANCE
4.ALL BURRS SHALL NOT EXCEED 0.05 MM,
MAXIMUM GATE VESTIGE FLUSH OR BELOW
A 5. SPEC. PLS. REFER TO EI053:
. DIM. MARKED (XX) SHOULD BE MEASURED BY FAI;
. DIM. MARKED (C) SHOULD BE CONTROLLED BY QC;
. DIM. MARKED M SHOULD BE MEASURED TERMLY BY QC;
. DIM. MARKED CPK SHOULD BE ANALYSED TERMLY BY QC;
6.ORDERING INFORMATION:

WB2515 H -XX X X X
WITHOUT "H" : WITH HALOGEN
WITH "H" : HALOGEN FREE
PIN NO. 07:7P
COLOR:
B:BLACK
PLATING
GS: G/F ON CONTACT AREA ,
100u" MIN. MATTE TIN ON SOLDER AREA
NICKEL UNDER PLATED 50μ' MIN. OVER ALL.
PACKING
0:REEL





WORKING STATUS



NO.	DESCRIPTION	Q'TY.	MATERIAL
3	FORK	2	STEEL
2	TERMINAL	7	COPPER ALLOY
1	HOUSING	1	LCP

一般公差
TOLERANCES
X. ±0.2 .XX ±0.1
.X ±0.15 .XXX ±0.08
ANGLES ±2°

希尔盛精密电子(昆山)有限公司

檢驗尺寸標示
SYMBOLS Ⓒ Ⓜ INDICATE CLASSIFICATION DIMENSION
Ⓒ MARK IS CRITICAL DIM.
Ⓜ MARK IS MAJOR DIM.

品名 (TITLE): 7P SPRING BATTERY PITCH=2.5 H=7.6mm
圖號 (DWG NO.): C-WB2515H-07XXX

製圖 (DR): XUETAOGUO
審核 (CHKD): LEO-HE
核准 (APPD): LEO-HE

表面處理 (FINISH)
比例 (SCALE): 5:1
單位 (UNITS): mm
張數 (SHEET): 1 OF 1
SIZE: A4
REV: A